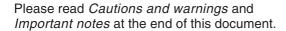


Size $18.54 \times 15.24 \times 7.11$ (mm)

Series/Type: B82479A1 Date: June 2012

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Size 18.54 x 15.24 x 7.11 (mm)

SMD

Rated inductance 1 ... 1000 µH Rated current 0.56 ... 8.6 A

Construction

- Ferrite core
- Winding: enamel copper wire
- Winding soldered to terminals
- Plastic terminal carrier

Features

- Temperature range up to +150 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- RoHS-compatible

Applications

- Filtering of supply voltages
- Coupling, decoupling
- DC/DC converters
- Automotive electronics
- Telecommunications
- Industrial electronics

Terminals

- Base material CuSn6P
- Layer composition Ni, Sn (lead-free)
- Electro-plated

Marking

- Marking on component: Manufacturer, L value (μH, coded), manufacturing date (YWWD)
- Minimum data on reel: Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing unit

- 32-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 250 pcs./reel





2 06/12

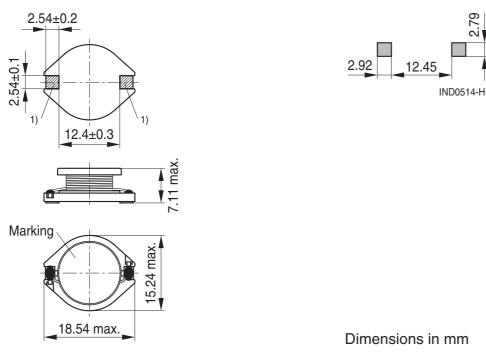
B82479A1



Size 18.54 x 15.24 x 7.11 (mm)

<u>SMD</u>

Dimensional drawing and layout recommendation



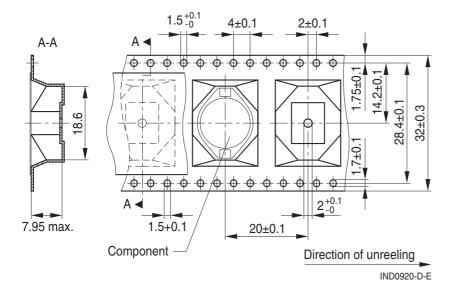
1) Soldering area

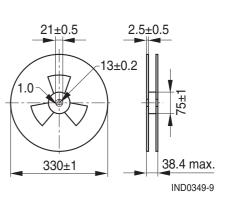
IND0513-B-E

Taping and packing

Blister tape

Reel





Dimensions in mm

B82479A1

Please read *Cautions and warnings* and *Important notes* at the end of this document.



Size 18.54 x 15.24 x 7.11 (mm)

<u>SMD</u>

Technical data and measuring conditions

| Rated inductance L _R | Measured with LCR meter Agilent 4284A at frequency $\rm f_L,0.1~V,$ +20 $^\circ\rm C$ | | | |
|----------------------------------|---|--|--|--|
| Rated temperature T _R | +85 °C | | | |
| Rated current I _R | Max. permissible DC with temperature increase of \leq 40 K at rated temperature | | | |
| Saturation current Isat | Max. permissible DC with inductance decrease $\Delta L/L_0$ of approx. 10% | | | |
| DC resistance R _{max} | Measured at +20 °C | | | |
| Solderability (lead-free) | Dip and look method Sn95.5Ag3.8Cu0.7: +(245 \pm 5) °C, (5 \pm 0.3) s Wetting of soldering area \geq 90% (based on IEC 60068-2-58) | | | |
| Resistance to soldering heat | +260 °C, 40 s (as referenced in JEDEC J-STD 020D) | | | |
| Climatic category | 55/150/56 (to IEC 60068-1) | | | |
| Storage conditions | Mounted: -55 °C +150 °C Packaged: -25 °C +40 °C, ≤75% RH | | | |
| Weight | Approx. 3 g | | | |

Characteristics and ordering codes

| L _R | Tolerance | fL | I _R | I _{sat} | R _{max} | Ordering code |
|----------------|-----------|-----|----------------|------------------|------------------|-----------------|
| μH | | MHz | А | А | Ω | |
| 1.0 | ±20% ≙ M | 0.1 | 8.60 | 20 | 0.011 | B82479A1102M000 |
| 2.2 | | 0.1 | 7.10 | 16 | 0.014 | B82479A1222M000 |
| 3.3 | | 0.1 | 6.20 | 14 | 0.016 | B82479A1332M000 |
| 5.6 | _ | 0.1 | 5.30 | 12 | 0.022 | B82479A1562M000 |
| 10 | | 0.1 | 4.30 | 10 | 0.032 | B82479A1103M000 |
| 15 | | 0.1 | 4.00 | 8.0 | 0.036 | B82479A1153M000 |
| 22 | | 0.1 | 3.50 | 7.0 | 0.047 | B82479A1223M000 |
| 33 | | 0.1 | 3.00 | 5.5 | 0.066 | B82479A1333M000 |
| 47 | | 0.1 | 2.60 | 4.5 | 0.087 | B82479A1473M000 |
| 68 | _ | 0.1 | 2.30 | 3.5 | 0.13 | B82479A1683M000 |
| 100 | | 0.1 | 1.80 | 3.0 | 0.19 | B82479A1104M000 |
| 150 | | 0.1 | 1.50 | 2.6 | 0.25 | B82479A1154M000 |
| 220 | | 0.1 | 1.20 | 2.4 | 0.38 | B82479A1224M000 |
| 330 | | 0.1 | 1.00 | 1.9 | 0.56 | B82479A1334M000 |
| 470 | | 0.1 | 0.82 | 1.4 | 0.85 | B82479A1474M000 |
| 680 | | 0.1 | 0.72 | 1.2 | 1.20 | B82479A1684M000 |
| 1000 | | 0.1 | 0.56 | 1.0 | 1.80 | B82479A1105M000 |

Sample kit available (see also page 11). Ordering code: B8247XX001

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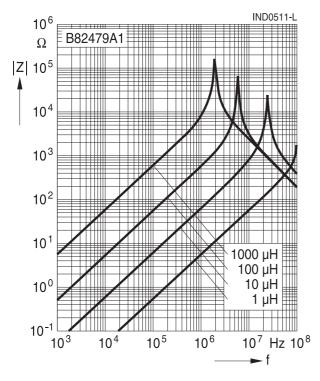


Size 18.54 x 15.24 x 7.11 (mm)

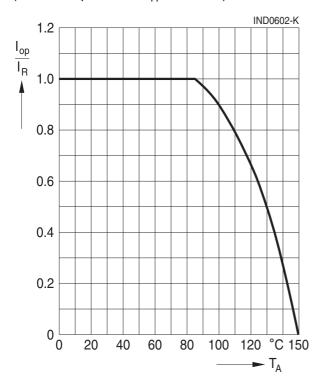
SMD

Impedance IZI versus frequency f measured with impedance analyzer

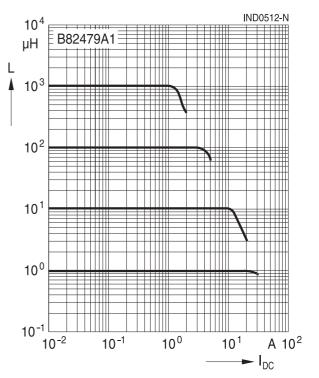
Agilent 4294A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature T_A (rated temperature $T_B = +85 \ ^\circ C$)



Inductance L versus DC load current I_{DC} measured with LCR meter Agilent 4275A, typical values at 20 °C



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Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
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Release 2018-10

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